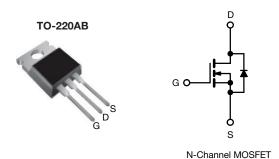
Vishay Siliconix

COMPLIANT

HALOGEN FREE

E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.18		
Q _g max. (nC)	86			
Q _{gs} (nC)	11			
Q _{gd} (nC)	24			
Configuration	Single			



FEATURES

- ullet Low figure-of-merit (FOM) $R_{on} \times Q_g$
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	SiHP22N60E-E3		
Lead (Pb)-free and Halogen-free	SiHP22N60E-GE3		

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	v
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	21	
		T _C = 100 °C		13	Α
Pulsed Drain Current ^a			I _{DM}	56	
Linear Derating Factor				1.8	W/°C
Single Pulse Avalanche Energy b			E _{AS}	367	mJ
Maximum Power Dissipation			P _D	227	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C		d\//d+	70	V/ns
Reverse Diode dV/dt ^d		dV/dt	11	V/ns	
Soldering Recommendations (Peak temperature) c	for 10 s			300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A.
- c. 1.6 mm from case.
- d. $I_{SD} \leq I_{D}, \, dI/dt = 100 \; A/\mu s, \, starting \; T_{J} = 25 \; ^{\circ}C.$



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.55	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-					•
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 250 μA		-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2	-	4	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I_{GSS}		V _{GS} = ± 30 V		_	± 1	μΑ
			$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	μΑ
Zero Gate Voltage Drain Current	I_{DSS}	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	_	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	0.15	0.18	Ω
Forward Transconductance	9fs	V _{DS} = 8 V, I _D = 5 A		-	6.4	-	S
Dynamic		1			·		
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	1920	-	pF
Output Capacitance	Coss			-	90	-	
Reverse Transfer Capacitance	C _{rss}			-	6	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	73	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	263	-	
Total Gate Charge	Qg			-	57	86	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V		11	-	nC
Gate-Drain Charge	Q _{gd}			-	24	-	1
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 380 \text{ V}, I_{D} = 11 \text{ A}, \ V_{GS} = 10 \text{ V}, R_{g} = 4.7 \Omega$		-	18	36	ns
Rise Time	t _r			-	27	54	
Turn-Off Delay Time	t _{d(off)}			-	66	99	
Fall Time	t _f			-	35	70	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		0.3	0.77	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	21	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	56	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	-		-	344	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 11 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		_	5.3	-	μC
Reverse Recovery Current	I _{RRM}			_	28		A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

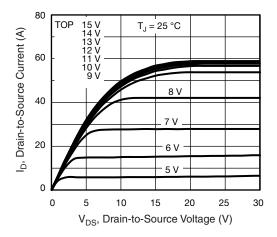


Fig. 1 - Typical Output Characteristics

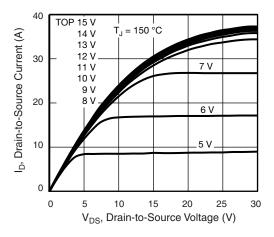


Fig. 2 - Typical Output Characteristics

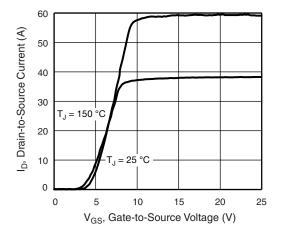


Fig. 3 - Typical Transfer Characteristics

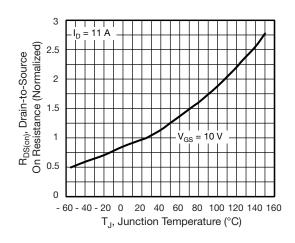


Fig. 4 - Normalized On-Resistance vs. Temperature

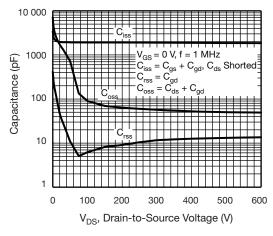


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

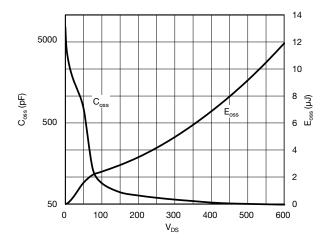


Fig. 6 - Coss and Eoss vs. VDS



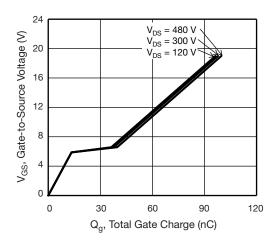


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

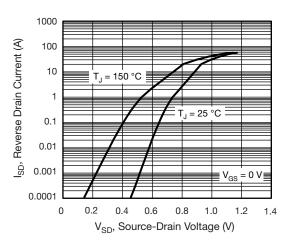


Fig. 8 - Typical Source-Drain Diode Forward Voltage

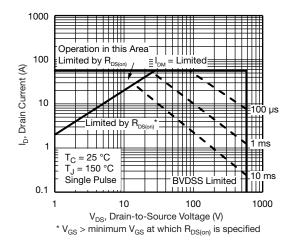


Fig. 9 - Maximum Safe Operating Area

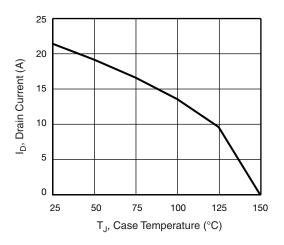


Fig. 10 - Maximum Drain Current vs. Case Temperature

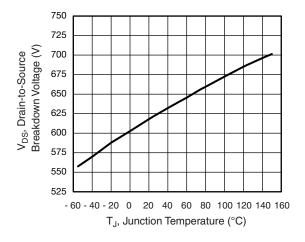


Fig. 11 - Temperature vs. Drain-to-Source Voltage



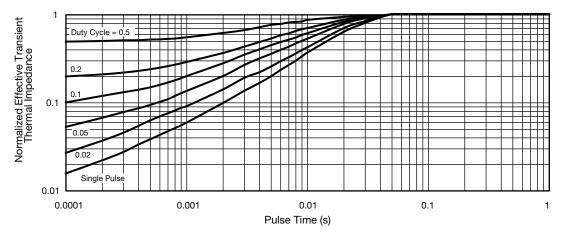


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

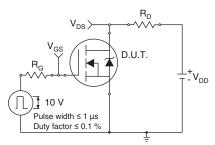


Fig. 13 - Switching Time Test Circuit

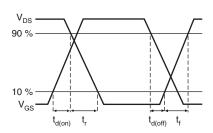


Fig. 14 - Switching Time Waveforms

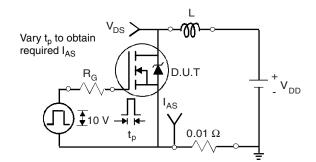


Fig. 15 - Unclamped Inductive Test Circuit

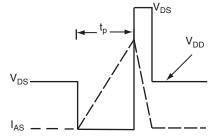


Fig. 16 - Unclamped Inductive Waveforms

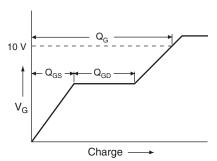


Fig. 17 - Basic Gate Charge Waveform

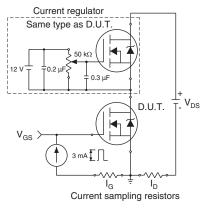
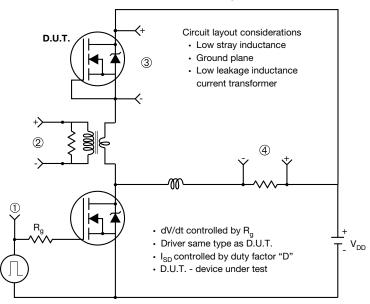


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



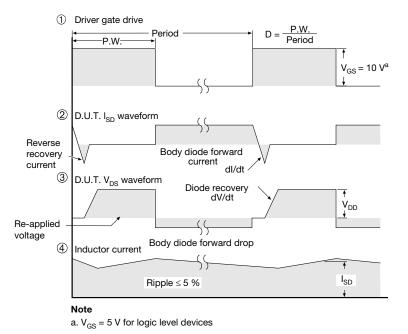


Fig. 19 - For N-Channel

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